06-28-01 EXPRESS MAIL NO. EL755729994US PTO/SB/21 (08-00) Please type a plus sign Approved for use through 10/31/2002. OMB 0651-0031 inside this box -U.S. Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE Under the Paper of Reduction Act of 1995, no persons are required to respond to a collection of information unless it displays a valid OMB control number. **Application Number** 09/632,388 **TRANSMITTAL** Filing Date August 3, 2000 **FORM** First Named Inventor Shin Hwa Li Group Art Unit 2823 (To be used for all correspondence after initial filing) **Kurt Eaton Examiner Name** 

<u> </u>	Attorney Do	ocket No.	98-P-009C1(850063.529C1)				
ENCLOSURES (check all that apply)							
Fee Transmittal Form Fee Attached Amendment/Response After Final Affidavits/declaration(s) Extension of Time Request Express Abandonment Request Information Disclosure Statement; Form PTO-1449 Cited References Certified Copy of Priority Document(s) Response to Missing Parts under 37 C.F.R. 1.52 or 1.53 Response to Missing Parts/Incomplete Application	Assignment Papers (for an Application) Drawing(s) Request for Corrected Filir Receipt Licensing-related Papers Petition Petition to Convert to a Provisional Application Power of Attorney, Revocation, Change of Correspondence Address Declaration Statement under 37 CFR 3.73(b) Terminal Disclaimer Small Entity Statement Request for Refund	of Africa Applications of Appl	ter Allowance ommunication to Group opeal Communication to Group opeal Communication to pard of Appeals and derferences opeal Communication to oup (Appeal Notice, Brief, eply Brief) oprietary Information atus Letter eturn Receipt Postcard (ditional Enclosure(s) lease identify below):				
SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT							

<u>Itemarks</u>						
SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT						
Individual Name	<del></del>	onick (Reg. No.		28899		
			· //	PATENT TRADEMARK OFFICE		
Signature	Mar	les 1/6	Just /			
Date	June 27, 2001					
CERTIFICATE OF MAILING						
I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231 on the date specified below.						
Typed or printed r	name					
Signature				Date:		
				· · · · · · · · · · · · · · · · · · ·		



## **EXPRESS MAIL NO. EL755729994US**

777124

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

**Applicants** 

Shin Hwa Li et al.

Application No

09/632,388

Filed

August 3, 2000

For

SEMICONDUCTOR STRUCTURE HAVING AN IMPROVED

PRE-METAL DIELECTRIC STACK AND METHOD FOR

FORMING THE SAME

Art Unit

2823

Docket No.

98-P-009C1 (850063.529c1)

Date

June 27, 2001

Box Non-Fee Amendment Commissioner for Patents Washington, DC 20231

## **AMENDMENT**

Commissioner for Patents:

In response to the Office Action dated March 27, 2001, please amend the application as follows:

In the Claims:

Please add new claims 20-27 to read as follows:

20. (New) A semiconductor device sub-structure, comprising:

a substrate;

an oxide layer disposed over the substrate in a pattern having a physical contour of at least one or more recessed portions and at least one or more extended portions;